

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>David Tak-Wei HON</td> <td>08/08/2013</td> </tr> <tr> <td>Jingfeng Li</td> <td>08/08/2013</td> </tr> <tr> <td>Yiping MO</td> <td>08/08/2013</td> </tr> <tr> <td>Guangji DENG</td> <td>08/08/2013</td> </tr> </tbody> </table>		Name	Execution Date	David Tak-Wei HON	08/08/2013	Jingfeng Li	08/08/2013	Yiping MO	08/08/2013	Guangji DENG	08/08/2013		
Name	Execution Date												
David Tak-Wei HON	08/08/2013												
Jingfeng Li	08/08/2013												
Yiping MO	08/08/2013												
Guangji DENG	08/08/2013												
RECEIVING PARTY DATA													
<table border="1"> <tr> <td>Name:</td> <td>Dahon Technologies, Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>Bldg.1-5, Xinyang Section, Furong Industrial Zone</td> </tr> <tr> <td>Internal Address:</td> <td>Shajing Town, Bao An</td> </tr> <tr> <td>City:</td> <td>Shenzhen City, Guangdong</td> </tr> <tr> <td>State/Country:</td> <td>CHINA</td> </tr> <tr> <td>Postal Code:</td> <td>518125</td> </tr> </table>		Name:	Dahon Technologies, Ltd.	Street Address:	Bldg.1-5, Xinyang Section, Furong Industrial Zone	Internal Address:	Shajing Town, Bao An	City:	Shenzhen City, Guangdong	State/Country:	CHINA	Postal Code:	518125
Name:	Dahon Technologies, Ltd.												
Street Address:	Bldg.1-5, Xinyang Section, Furong Industrial Zone												
Internal Address:	Shajing Town, Bao An												
City:	Shenzhen City, Guangdong												
State/Country:	CHINA												
Postal Code:	518125												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14000509</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14000509								
Property Type	Number												
Application Number:	14000509												
CORRESPONDENCE DATA													
<p>Fax Number: 9723672002 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 972-367-2001 Email: butz@cclaw.com Correspondent Name: Carstens & Cahoon, LLP Address Line 1: P.O. Box 802334 Address Line 4: Dallas, TEXAS 75240</p>													
ATTORNEY DOCKET NUMBER:	CACIP.00034												
NAME OF SUBMITTER:	Colin P. Cahoon, USPTO Reg. No. 38836												
Signature:	/Colin P. Cahoon, USPTO Reg. No. 38836/												

PATENT

Date:	08/29/2013
Total Attachments: 2 source=Executed_Assignment#page1.tif source=Executed_Assignment#page2.tif	

ASSIGNMENT

WHEREAS, I, David Tak-Wei HON, a citizen of the United States, residing at Bldg.1-5, Xinyang Section, Furong Industrial Zone, Shajing Town, Bao An, Shenzhen City, Guangdong 518125 China; Jingfeng LI, a citizen of China, residing at Bldg.1-5, Xinyang Section, Furong Industrial Zone, Shajing Town, Bao An, Shenzhen City, Guangdong 518125 China; Yiping MO, a citizen of China, residing at Bldg.1-5, Xinyang Section, Furong Industrial Zone, Shajing Town, Bao An, Shenzhen City, Guangdong 518125 China; and Guangji DENG, a citizen of China, residing at Bldg.1-5, Xinyang Section, Furong Industrial Zone, Shajing Town, Bao An, Shenzhen City, Guangdong 518125 China, a joint-inventor of the invention entitled **Spanner Tool**, for which we have executed an application for Letters Patent of the United States with attorney reference number CACIP.00034; and

WHEREAS, Dahon Technologies, Ltd., incorporated in China [CN], with a place of business at Bldg.1-5, Xinyang Section, Furong Industrial Zone, Shajing Town, Bao An, Shenzhen City, Guangdong 518125 China, (hereinafter, Assignee) is desirous of obtaining the entire right, title, and interest in, to, and under the said invention and the said application;

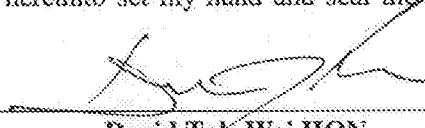
NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the said David Tak-Wei HON, Jingfeng LI, Yiping MO, and Guangji DENG have sold, assigned, transferred, and set over, and by these presents do hereby sell, assign, transfer, and set over, unto the said Dahon Technologies, Ltd., its successors, legal representatives, and assigns, the entire right, title, and interest in, to, and under the said invention, and the said application and all divisions, renewals, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said invention in any country or countries foreign to the United States, and all Letters Patent which may be granted for said invention in any country or countries foreign to the United States, and all extensions, renewals, and reissues thereof, and all rights of priority in any such country or countries based upon the filing of the said application for Letters Patent of the United States which are created by any law, treaty, or international convention; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said Dahon Technologies, Ltd., its successors, legal representatives, and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to said Dahon Technologies, Ltd., its successors, legal representatives, and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally do

everything possible to aid the said Dahon Technologies, Ltd., its successors, legal representatives, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my signature.

Date: 8. August, 2013  L.S.
David Tak-Wei HON

Date: 8. August, 2013 Jingfeng Li L.S.
Jingfeng LI

Date: 8. August, 2013 Yiping Mo L.S.
Yiping MO

Date: 8. August, 2013 Guangji DENG L.S.
Guangji DENG